



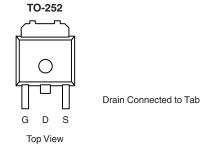
N-Channel 100-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
100	0.025 at V _{GS} = 10 V	40		
	0.028 at V _{GS} = 4.5 V	38		

FEATURES

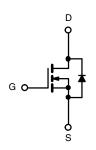
- TrenchFET® Power MOSFET
- 175 °C Maximum Junction Temperature
- 100 % R_q Tested





Ordering Information: SUD40N10-25

SUD40N10-25-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 2$	25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Dunin Comment /T 475 90\h	T _C = 25 °C	L	40		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	l ID	23		
Pulsed Drain Current		I _{DM}	70	Α	
Continuous Source Current (Diode Conduction)		I _S	40		
Avalanche Current		I _{AS}	40	1	
Single Pulse Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	80	mJ	
	T _C = 25 °C	ь	136 ^b	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^a	W	
Operating Junction and Storage Temperature Range	·	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Lucation to Ambient	t ≤ 10 s	R _{thJA}	15	18	°C/W
Junction-to-Ambient ^a	Steady State		40	50	
Junction-to-Case		R _{thJC}	0.85	1.1	

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

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^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static					<u> </u>		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		3.0		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V			1		
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	70			Α	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 40 A		0.02	0.025		
	R _{DS(on)}	V _{GS} = 10 V, I _D = 40 A, T _J = 125 °C			0.05	Ω	
		V _{GS} = 10 V, I _D = 40 A, T _J = 175 °C			0.063		
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.022	0.028		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 40 A		70		S	
Dynamic ^a							
Input Capacitance	C _{iss}			2400		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, F = 1 MHz		290			
Reverse Transfer Capacitance	C _{rss}			120			
Total Gate Charge ^c	Qg			40	60		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 40 \text{ A}$		11		nC	
Gate-Drain Charge ^c	Q _{gd}			9			
Gate Resistance	Rg		1		3.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	13		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 1.25 Ω I_D \cong 40 A, V_{GEN} = 10 V, R_g = 2.5 Ω		40	60		
Turn-Off Delay Time ^c	t _{d(off)}			15	25	ns	
Fall Time ^c	t _f			80	120		
Source-Drain Diode Ratings and Char	racteristics 7	T _C = 25 °C					
Pulsed Current	I _{SM}				70	Α	
Diode Forward Voltage ^b	V _{SD}	I _F = 40 A, V _{GS} = 0 V		1.0	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 40 A, dl/dt = 100 A/μs		75	120	ns	

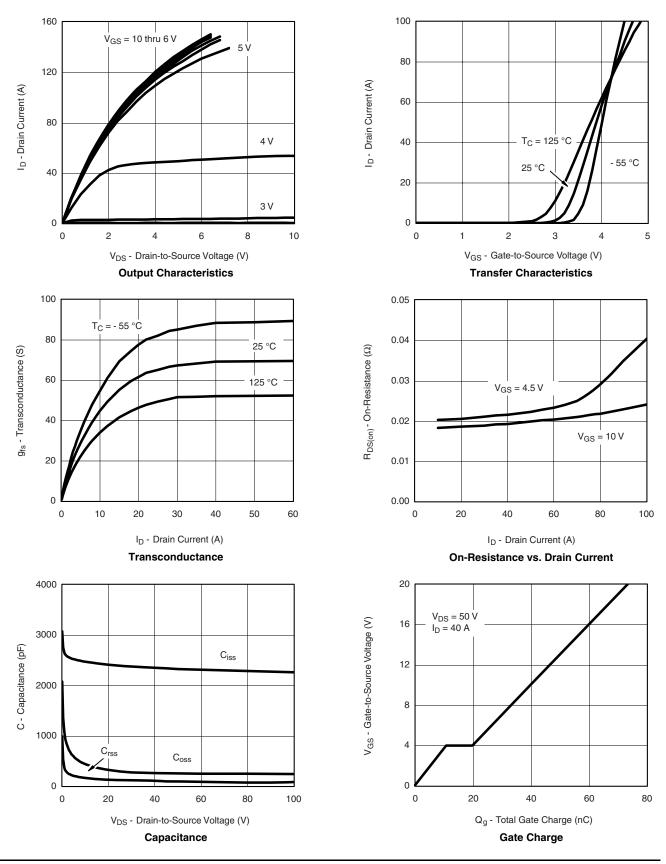
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

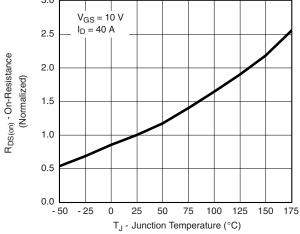


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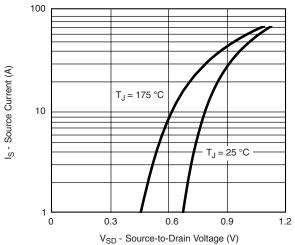
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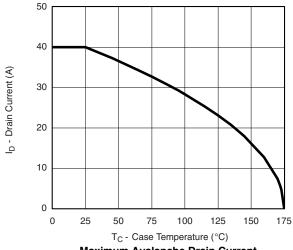


On-Resistance vs. Junction Temperature

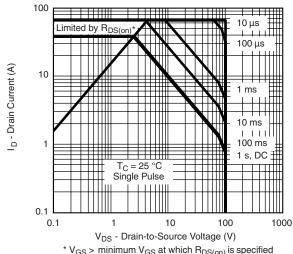


Source-Drain Diode Forward Voltage

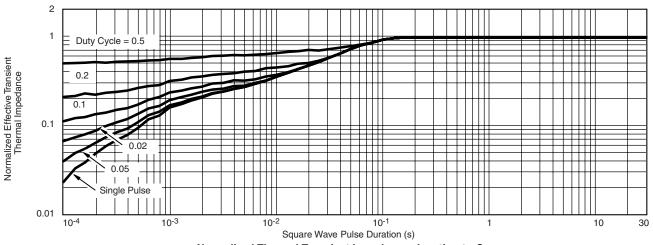
THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature



 * V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Case

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